INTEGRATED CIRCUITS

DATA SHEET

74LVC240A

Octal buffer/line driver with 5-volt tolerant inputs/outputs; inverting (3-State)

Product specification IC24 Data Handbook





Octal buffer/line driver with 5-volt tolerant inputs/outputs; inverting (3-State)

74LVC240A

FEATURES

- 5-volt tolerant inputs/outputs, for interfacing with 5-volt logic
- Supply voltage range of 1.2V to 3.6V
- Complies with JEDEC standard no. 8-1A
- CMOS low power consumption
- Direct interface with TTL levels
- High impedance when V_{CC} = 0V

DESCRIPTION

The 74LVC240A is a high-performance, low-power, low-voltage, Si-gate CMOS device, superior to most advanced CMOS compatible TTL families.

Inputs can be driven from either 3.3V or 5V devices. In 3-State operation, outputs can handle 5V. These features allow the use of these devices as translators in a mixed 3.3V/5V environment.

The '240A is an octal non-inverting buffer/line driver with 3-State outputs. The 3-State outputs are controlled by the output enable inputs $1\overline{OE}$ and $2\overline{OE}$. A HIGH on $n\overline{OE}$ causes the outputs to assume a high impedance OFF-state. Schmitt-trigger action at all inputs makes the circuit highly tolerant for slower input rise and fall

The '240' is functionally identical to the '244', but the '244' has inverting outputs.

QUICK REFERENCE DATA

GND = 0 V; $T_{amb} = 25^{\circ}C$; $t_r = t_f \le 2.5 \text{ ns}$

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
t _{PHL} /t _{PLH}	Propagation delay 1A _n to 1Y _{n;} 2A _n to 2Y _n	$C_L = 50pF$ $V_{CC} = 3.3V$	3.5	ns
C _I	Input capacitance		5.0	pF
C _{PD}	Power dissipation capacitance per buffer	Notes 1 and 2	20	pF

NOTE:

- 1. C_{PD} is used to determine the dynamic power dissipation (P_D in μW):
 - $P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:
 - f_i = input frequency in MHz; C_L = output load capacity in pF; f_o = output frequency in MHz; V_{CC} = supply voltage in V;
- Σ (C_L x V_{CC}² x f₀) = sum of outputs. 2. The condition is V_I = GND to V_{CC}

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #	
20-Pin Plastic Small Outline (SO)	–40°C to +85°C	74LVC240A D	74LVC240A D	SOT163-1	
20-Pin Plastic Shrink Small Outline (SSOP) Type II	–40°C to +85°C	74LVC240A DB	74LVC240A DB	SOT339-1	
20-Pin Plastic Thin Shrink Small Outline (TSSOP) Type I	–40°C to +85°C	74LVC240A PW	7LVC240APW DH	SOT360-1	

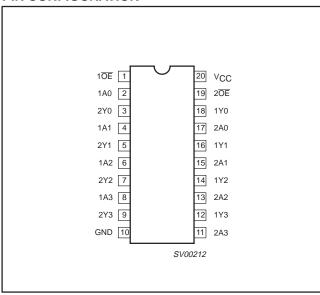
Octal buffer/line driver with 5-volt tolerant inputs/outputs; inverting (3-State)

74LVC240A

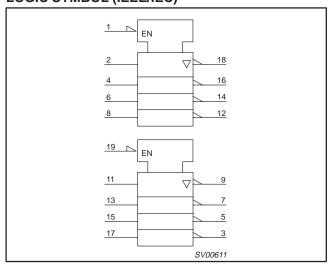
PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION
1	1 OE	Output enable input (active LOW)
2, 4, 6, 8	1A ₀ to 1A ₃	Data inputs
3, 5, 7, 9	2Y ₀ to 2Y ₃	Bus outputs
10	GND	Ground (0V)
17, 15, 13, 11	2A ₀ to 2A ₃	Bus inputs
18, 16, 14, 12	1Y ₀ to 1Y ₃	Bus outputs
19	20E	Output enable input (active-LOW)
20	V _{CC}	Positive power supply

PIN CONFIGURATION



LOGIC SYMBOL (IEEE/IEC)



FUNCTION TABLE

INP	JTS	OUTPUT
nOE	nA _n	nY _n
L	L	Н
L	Н	L
Н	Х	Z

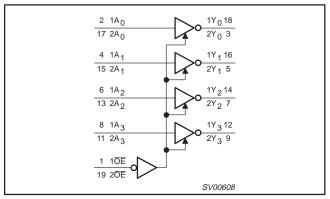
H = HIGH voltage level

L = LOW voltage level

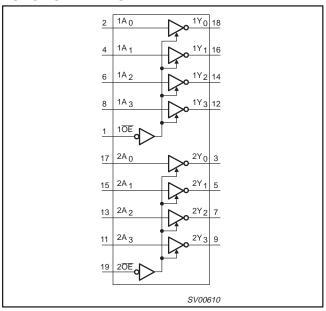
X = Don't care

Z = High impedance OFF-state

LOGIC SYMBOL



FUNCTIONAL DIAGRAM



Octal buffer/line driver with 5-volt tolerant inputs/outputs; inverting (3-State)

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RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	LIM	IITS	UNIT
STWIBOL	PARAIVIETER	CONDITIONS	MIN	MAX	UNIT
V _{CC}	DC supply voltage (for max. speed performance)		2.7	3.6	V
V _{CC}	DC supply voltage (for low-voltage applications)		1.2	3.6	V
VI	DC Input voltage range		0	5.5	V
Vo	DC Output voltage range; output HIGH or LOW state		0	V _{CC}	V
	DC output voltage range; output 3-State		0	5.5	
T _{amb}	Operating ambient temperature range in free-air		-40	+85	°C
t _r , t _f	Input rise and fall times	$V_{CC} = 1.2 \text{ to } 2.7V$ $V_{CC} = 2.7 \text{ to } 3.6V$	0	20 10	ns/V

ABSOLUTE MAXIMUM RATINGS¹

In accordance with the Absolute Maximum Rating System (IEC 134) Voltages are referenced to GND (ground = 0V)

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +6.5	V
I _{IK}	DC input diode current	V _I < 0	-50	mA
VI	DC input voltage	Note 2	-0.5 to +6.5	V
I _{OK}	DC output diode current	$V_{O} > V_{CC}$ or $V_{O} < 0$	±50	mA
\/	DC output voltage; output HIGH or LOW state	Note 2	-0.5 to V _{CC} +0.5	V
Vo	DC output voltage; output 3-State	Note 2	-0.5 to 6.5	V
I _O	DC output source or sink current	$V_O = 0$ to V_{CC}	±50	mA
I _{GND} , I _{CC}	DC V _{CC} or GND current		±100	mA
T _{stg}	Storage temperature range		-65 to +150	°C
P _{TOT}	Power dissipation per package – plastic mini-pack (SO) – plastic shrink mini-pack (SSOP and TSSOP)	above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	500 500	mW

NOTES

Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the
device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to
absolute-maximum-rated conditions for extended periods may affect device reliability.

^{2.} The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

Octal buffer/line driver with 5-volt tolerant inputs/outputs; inverting (3-State)

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DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions voltages are referenced to GND (ground = 0V)

			L	IMITS		
SYMBOL	PARAMETER	TEST CONDITIONS	Temp = -] TINU		
			MIN	TYP ¹	MAX	1
.,	LUCLI laval land tualiana	V _{CC} = 1.2V	V _{CC}			V
V _{IH}	HIGH level Input voltage	V _{CC} = 2.7 to 3.6V	2.0			1 ^v
V	LOW/Journal James to contract of	V _{CC} = 1.2V			GND	V
V _{IL}	LOW level Input voltage	V _{CC} = 2.7 to 3.6V			0.8	1 ^v
		$V_{CC} = 2.7V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = -12$ mA	V _{CC} -0.5			
	LUCLI lovel autout valtage	$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = -100 \mu\text{A}$	V _{CC} -0.2	V _{CC}		$\Big]_{\ \ \lor}$
∨он	V _{OH} HIGH level output voltage	$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = -18$ mA	V _{CC} -0.6			1 ^v
		$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = -24$ mA	V _{CC} -0.8]
		$V_{CC} = 2.7V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 12mA$			0.40	
V _{OL}	LOW level output voltage	$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 100\mu A$		GND	0.20	V
		$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 24$ mA			0.55]
t _l	Input leakage current ²	V _{CC} = 3.6V; V _I = 5.5V or GND		±0.1	±5	μΑ
l _{OZ}	3-State output OFF-state current	$V_{CC} = 3.6V$; $V_I = V_{IH}$ or V_{IL} ; $V_O = 5.5V$ or GND		0.1	±10	μΑ
I _{off}	Power off leakage current	$V_{CC} = 0.0V; V_{I} \text{ or } V_{O} = 5.5V$		0.1	±10	μА
I _{CC}	Quiescent supply current	$V_{CC} = 3.6V$; $V_I = V_{CC}$ or GND; $I_O = 0$		0.1	10	μΑ
Δl _{CC}	Additional quiescent supply current per input pin	$V_{CC} = 2.7V$ to 3.6V; $V_{I} = V_{CC} - 0.6V$; $I_{O} = 0$		5	500	μА

- All typical values are at V_{CC} = 3.3V and T_{amb} = 25°C.
 The specified overdrive current at the data input forces the data input to the opposite logic input state.

AC CHARACTERISTICS

GND = 0V; t_r = $t_f \le$ 2.5ns; C_L = 50pF; R_L = 500 Ω ; T_{amb} = -40°C to +85°C.

			LIMITS							
SYMBOL	PARAMETER	WAVEFORM	V _{CC}	= 3.3V ±0).3V	V _{CC} =	2.7V	V _{CC} = 1.2V	UNIT	
			MIN	TYP ¹	MAX	MIN	MAX	TYP		
t _{PLH}	Propagation delay 1A _n to 1Y _n ; 2A _n to 2Y _n	1, 3	1.5	3.5	6.5	1.5	7.5	16.0	ns	
t _{PZH} t _{PZL}	3-State output enable time 10E to 1Y _n ; 20E to 2Y _n	2, 3	1.5	4.3	8.0	1.5	9.0	19.0	ns	
t _{PHZ}	3-State output disable time 10E to 1Y _n ; 20E to 2Y _n	2, 3	1.5	3.7	7.0	1.5	8.0	17.0	ns	

NOTE:

^{1.} Unless otherwise stated, all typical values are at V_{CC} = 3.3V and T_{amb} = 25°C.

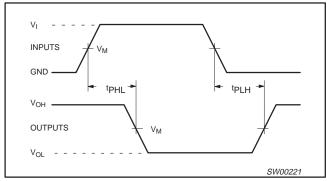
Octal buffer/line driver with 5-volt tolerant inputs/outputs; inverting (3-State)

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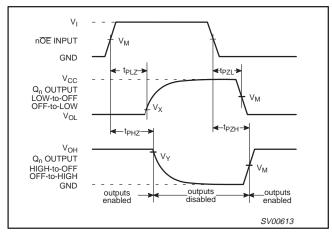
AC WAVEFORMS

 V_M = 1.5V at $V_{CC} \ge 2.7V; \, V_M$ = 0.5 V_{CC} at $V_{CC} < 2.7V.$ V_{OL} and V_{OH} are the typical output voltage drop that occur with the output load.

V_X = V_{OL} + 0.3V at V_{CC} \geq 2.7V; V_X = V_{OL} + 0.1 V_{CC} at V_{CC} < 2.7V V_Y = V_{OH} -0.3V at V_{CC} \geq 2.7V; V_Y = V_{OH} - 0.1 V_{CC} at V_{CC} < 2.7V

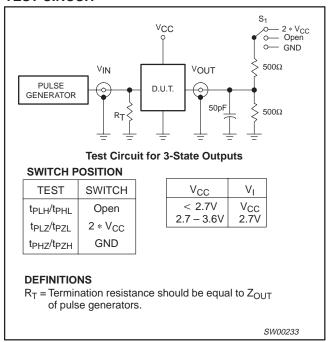


Waveform 1. Inputs $(1A_n, 2A_n)$ to outputs $(1Y_n, 2Y_n)$ propagation delays.



Waveform 2. 3-State enable and disable times.

TEST CIRCUIT



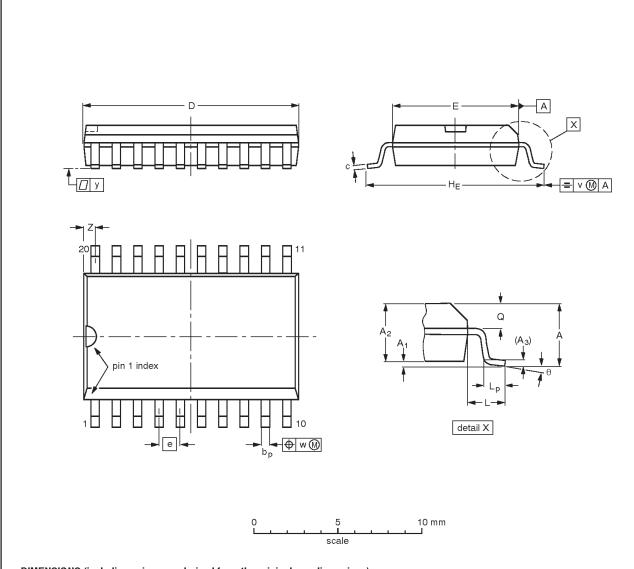
Waveform 3. Load circuitry for switching times.

Octal buffer/line driver with 5-volt tolerant inputs/outputs; inverting (3-State);

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SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	e	HE	L	Lp	Q	v	w	у	z ⁽¹⁾	θ
mm	2.65	0.30 0.10	2.45 2.25	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8°
inches	0.10	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.050	0.42 0.39	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	o°

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

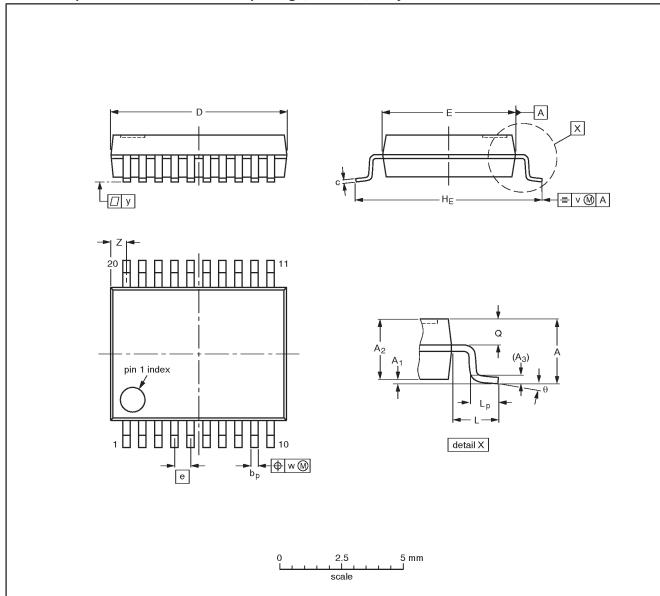
OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT163-1	075E04	MS-013AC			-92-11-17 95-01-24

Octal buffer/line driver with 5-volt tolerant inputs/outputs; inverting (3-State);

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SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	Α1	A ₂	A ₃	bр	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	7.4 7.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.9 0.5	8° 0°

Note

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

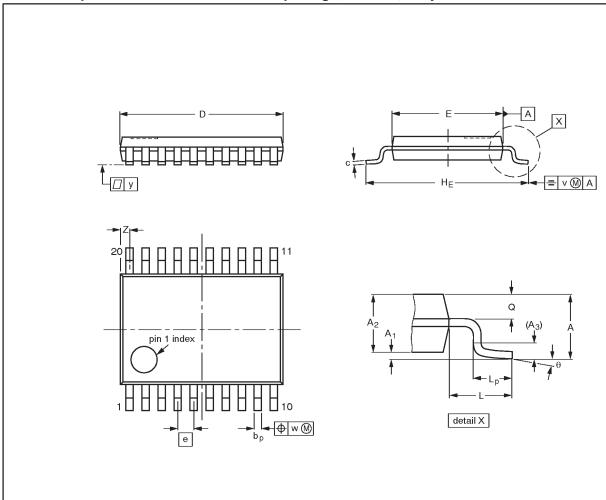
OUTLINE		EUROPEAN	ISSUE DATE				
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT339-1		MO-150AE				93-09-08 95-02-04	

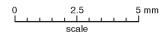
Octal buffer/line driver with 5-volt tolerant inputs/outputs; inverting (3-State);

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TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1





DIMENSIONS (mm are the original dimensions)

UNIT	A max.	Α1	A ₂	A ₃	рb	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	6.6 6.4	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT360-1		MO-153AC			-93-06-16 95-02-04

Octal buffer/line driver with 5-volt tolerant inputs/outputs; inverting (3-State);

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NOTES

74LVC240A

Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
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^[1] Please consult the most recently issued datasheet before initiating or completing a design.

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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print code Date of release: 05-96

Document order number: 9397-750-04499

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